

S-NAUBA 5021

Wax Alloy Powder

Shamrock's product line of micronized waxes provide rub and abrasion resistance. Included in this line are products that provide gloss, matting, clarity, and controlled slip in a range of particle sizes.

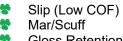
Product Description:

S-NAUBA 5021 is a concentrated blend of carnauba and synthetic wax showing melting peaks ranging from $84 - 110^{\circ}$ C.

Application:

S-NAUBA 5021 is used in both the ink and coating industry at a recommended level of 0.5-3.0%. S- NAUBA 5021 is recommended for both paste inks and powder coatings in all aqueous/solvent based systems.

Features and Benefits:



Gloss Retention

Typical Properties:

*	Specific Gravity: Particle Size Mean Value: NPIRI Grind: Hegman Grind:	1.0 g/cm ³ 7 μm 5.0 Max 6.5 Min	
	Hegman Grind:	6.5 MIN	

Regulatory Status:

The components of this product are listed on multiple chemical inventories. For specific information on the applicable chemical inventories, please refer to the product SDS.

Safety, Shipping and Handling:

For complete safety, shipping and handling information please contact your regional Customer Service Representative, or our Customer Service Team at customerserviceteam@shamrocktechnologies.com.

For **more** information about Shamrock's other products or capabilities please visit us at our website, ShamrockTechnologies.com.

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